

NCE N-Channel Super Trench Power MOSFET

Description

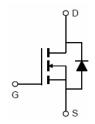
The NCEP15T14D uses **Super Trench** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of $R_{DS(ON)}$ and Q_g . This device is ideal for high-frequency switching and synchronous rectification.

General Features

- V_{DS} =150V, I_D =140A $R_{DS(ON)}$ =5.6m Ω , typical @ V_{GS} =10V
- Excellent gate charge x R_{DS(on)} product(FOM)
- Very low on-resistance R_{DS(on)}
- 175 °C operating temperature
- Pb-free lead plating
- 100% UIS tested

Application

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification



Schematic diagram



TO-263-2L top view

100% UIS TESTED!

100% AVds TESTED!

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCEP15T14D	NCEP15T14D	TO-263-2L	-	-	-

Absolute Maximum Ratings (T_C=25 ℃unless otherwise noted)

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Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V _{DS}	150	V		
Gate-Source Voltage	V _{GS}	±20	V		
Drain Current-Continuous	I _D	140	А		
Drain Current-Continuous(T _C =100 °C)	I _D (100℃)	100	А		
Pulsed Drain Current	I _{DM}	560	А		
Maximum Power Dissipation	P _D	320	W		
Derating factor		2.1	W/℃		
Single pulse avalanche energy (Note 5)	E _{AS}	1296	mJ		
Operating Junction and Storage Temperature Range	T_{J},T_{STG}	-55 To 175	$^{\circ}\mathbb{C}$		

Thermal Characteristic

Thermal Resistance, Junction-to-Case (Note 2)	$R_{ heta JC}$	0.47	°C/W



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Electrical Characteristics (T_C=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250μA	150	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =150V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V_{GS} =±20 V , V_{DS} =0 V	-	-	±100	nA
On Characteristics (Note 3)			-	l .		
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	2.0	3.0	4.0	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =70A	-	5.6	6.4	mΩ
Forward Transconductance	g FS	V _{DS} =10V,I _D =70A	70	-	-	S
Dynamic Characteristics (Note4)			-	l .		
Input Capacitance	C _{lss}	==	-	5500	-	PF
Output Capacitance	Coss	V_{DS} =75 V , V_{GS} =0 V ,	-	690	-	PF
Reverse Transfer Capacitance	C _{rss}	F=1.0MHz		7	-	PF
Switching Characteristics (Note 4)						•
Turn-on Delay Time	$t_{d(on)}$		-	26	-	nS
Turn-on Rise Time	t _r	V_{DD} =75 V , I_D =70 A	-	36	-	nS
Turn-Off Delay Time	$t_{\sf d(off)}$	V_{GS} =10 V , R_{G} =4.7 Ω	-	47	-	nS
Turn-Off Fall Time	t _f		-	15	-	nS
Total Gate Charge	Q_g	\/ 75\/ L 70A	-	80		nC
Gate-Source Charge	Q _{gs}	$V_{DS}=75V,I_{D}=70A,$	-	32		nC
Gate-Drain Charge	Q_{gd}	V _{GS} =10V	-	13		nC
Drain-Source Diode Characteristics			•	Į.		
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _F = I _S	-		1.2	V
Diode Forward Current (Note 2)	Is		-	-	140	Α
Reverse Recovery Time	t _{rr}	$T_J = 25^{\circ}C$, $I_F = I_S$	-	146		nS
Reverse Recovery Charge	Qrr	$di/dt = 100A/\mu s^{(Note3)}$	-	485		nC

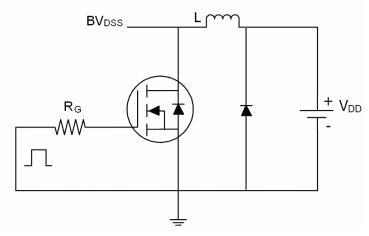
Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- 3. Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition : Tj=25 $^{\circ}\text{C}$,V $_{DD}$ =50 V,V $_{G}$ =10 V,L=0.5 mH,Rg=25 Ω

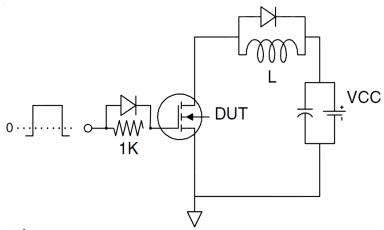


Test Circuit

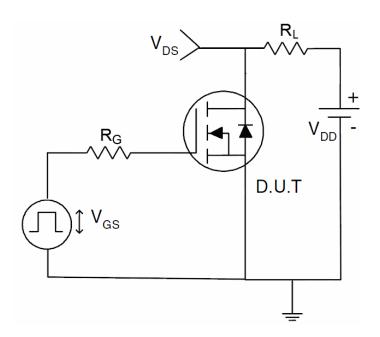
1) E_{AS} test Circuit



2) Gate charge test Circuit



3) Switch Time Test Circuit





Typical Electrical and Thermal Characteristics

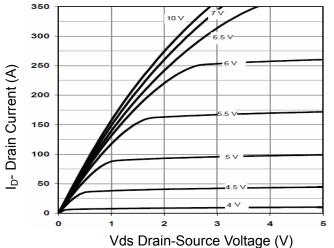


Figure 1 Output Characteristics

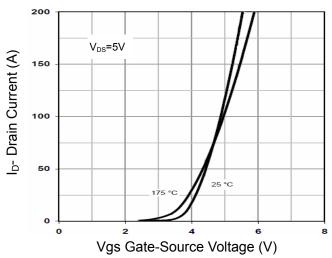


Figure 2 Transfer Characteristics

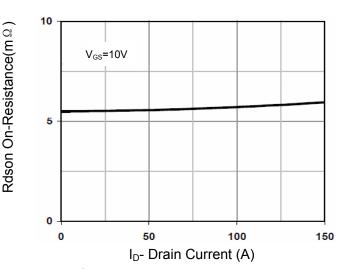


Figure 3 Rdson- Drain Current

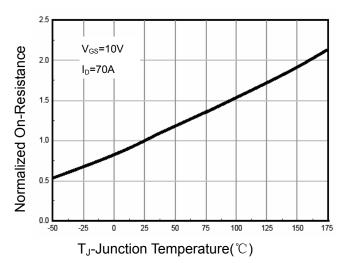


Figure 4 Rdson-JunctionTemperature

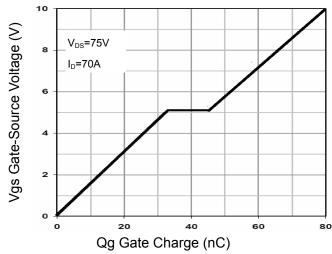


Figure 5 Gate Charge

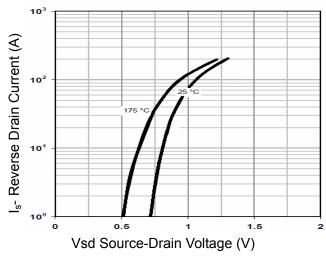
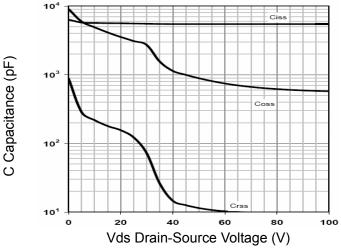


Figure 6 Source- Drain Diode Forward





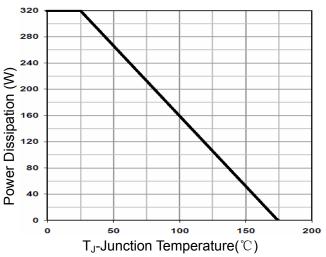
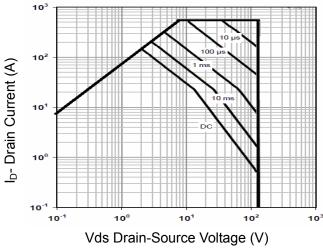


Figure 7 Capacitance vs Vds

Figure 9 Power De-rating



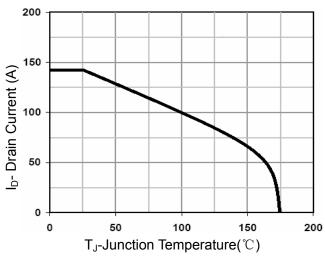


Figure 8 Safe Operation Area

Figure 10 Current De-rating

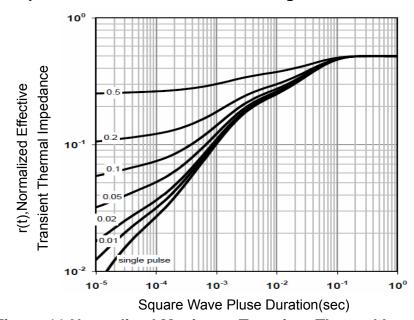
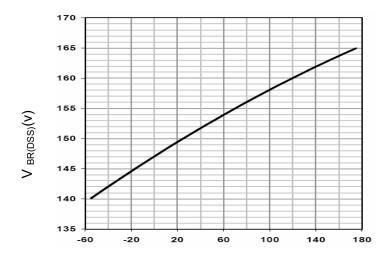


Figure 11 Normalized Maximum Transient Thermal Impedance



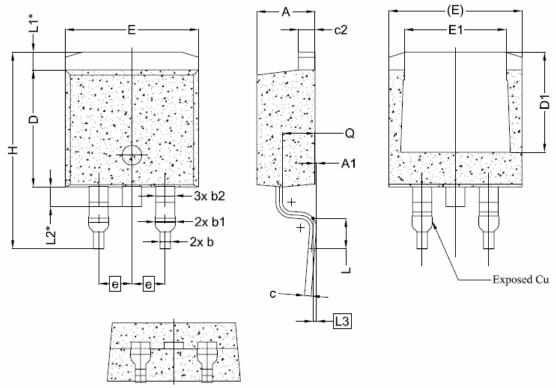


 $T_{J^{\text{-}}}$ Junction Temperature(${}^{\circ}\!\mathbb{C}$)

Figure 12 BV_{DSS} vs Junction Temperature

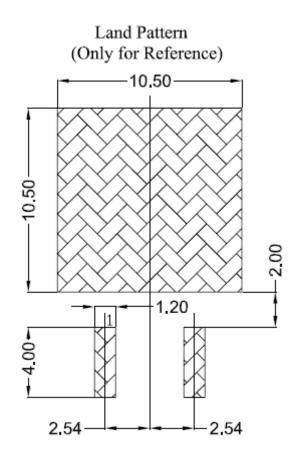


TO-263-2L Package Information



Symbol	Dimensions In Millimeters			
Symbol	Min.	Nom.	Max.	
А	4.24	4.24 4.44		
A1	0.00	0.10	0.25	
b	0.70	0.80	0.90	
b1	1.20	1.55	1.75	
b2	1.20	1.45	1.70	
С	0.40	0.50	0.60	
c2	1.15	1.27	1.40	
D	8.82	8.92	9.02	
D1	6.86	7.65	-	
E	9.96	10.16	10.36	
E1	6.89	7.77	7.89	
е	2.54BSC			
Н	14.61	14.61 15.00		
L	1.78 2.32		2.79	
L1	1.36 REF.			
L2	1.50 REF.			
L3	0.25 BSC			
Q	2.30	2.48	2.70	







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